

## **Specifications**

## SYSTEM

High Performance	Intel® 6th Gen Core™ i7-6820 EQ (Frequency 2.8 GHz, Turbo Boost up to 3.5		
Processor	GHz), Quad-Core, 8 Thread Support,8MB SmartCache. Build-in HD Graphics		
	530 for excellent 3D, Turbo Boost Technology 2.0, VPro and Hyper-Threading		
Ma	support		
Memory type	1 x DDR4 XR-DIMM		
	1 X DDR4 SO-DIMM Total up to 32 GB		
Chipset	Intel® QM170 Chipset supporting 6th generation Intel® Core™ processor		
Cimpset	families.		
DISPLAY			
Display Port	Resolution up to 3840 x 2160		
DVI-I	Resolution up to 1920 x 1200		
STORAGE			
mSATA	mSATA Solid State Disk (SSD) - up to 512GB Capacity.		
Onboard SSD	Onboard uSSD 64GB		
REAR I/O			
Display Port	2 x 20Pin External connectors (Female)		
DVI-I	1 x 29Pin DVI-I connector (Female)		
Ethernet	2 x RJ45 Gigabit Ethernet LAN 'FNBMF		
Audio	2 x 3.5mm Audio Jacks (1 x MIC, 1 x Line-Out)		
Serial Port	1 x DB9 connector (RS-232/422/485)		
USB Port	2 x USB3.0 standard-A connectors		
DC-IN	1 x4 Pin rugged terminal block		
FRONT I/O			
Button	Power Button w/cover		
Indicator LED	Power, HDD, LAN (Link/Active/Speed)		
USB Port	2 x USB3.0 standard-A connectors		
APPLICATIONS, O	PERATING SYSTEM		
Applications	Energy/Smart Grid/Power Plant Management, Intelligent Automation and		

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Operating System	Windows 8, Windows 8.1, Windows 10, Ubuntu14.04, Ubuntu16.04		
PHYSICAL			
Dimension (W x D x H)	308 x 149 x 58mm		
Weight	2.96Kg		
Chassis	Aluminum Alloy, Corrosion Resistant		
Finish	Anodic aluminum oxide (Color Iron gray)		
Cooling	Natural Passive Convection/Conduction. No Moving Parts		
Relative Humidity	5% to 95% non-condensing		
Ingress Protection	Dust Proof (Similar to IP50)		
ENVIRONMENTAL			
MIL-STD-810G Test	Method 507.5, Procedure II (Temperature & Humidity)		
	Method 516.6 Shock-Procedure V Non-Operating (Mechanical Shock)		
	Method 516.6 Shock-Procedure I Operating (Mechanical Shock)		
	Method 514.6 Vibration Category 24/Non-Operating (Category 20 & 24,		
	Vibration)		
	Method 514.6 Vibration Category 20/Operating (Category 20 & 24,		
	Vibration)		
	Method 501.5, Procedure I (Storage/High Temperature)		
	Method 501.5, Procedure II (Operation/High Temperature)		
	Method 502.5, Procedure I (Storage/Low Temperature)		
	Method 502.5, Procedure II (Operation/Low Temperature)		
	Method 503.5, Procedure I (Temperature shock)		
Operating Temperature	-40 to 60°C (ambient with airflow)		
Storage Temperature	-40 to 85°C		
EMC	CE and FCC compliance		
Green Product	RoHS, WEEE compliance		

## **Ordering Information**

SR10-SCHX2

MIL-STD-810G Rugged computer with Intel® Core™ i7-6820EQ, μSSD 64GB onboard, 9V to 36V DC-in, Extended Temp. -40~60°C